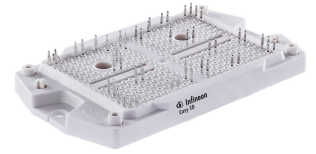


EasyPIM™ module with TRENCHSTOP™ IGBT7 and emitter controlled 7 diode and PressFIT / NTC

Features

- Electrical features
 - $V_{CES} = 1200\text{ V}$
 - $I_{C\text{nom}} = 100\text{ A} / I_{CRM} = 200\text{ A}$
 - TRENCHSTOP™ IGBT7
 - Low $V_{CE,\text{sat}}$
 - Overload operation up to 175°C
- Mechanical features
 - High power density
 - Compact design
 - Al_2O_3 substrate with low thermal resistance
 - 2.5 kV AC 1 minute insulation
 - PressFIT contact technology



Potential applications

- Air conditioning
- Auxiliary inverters
- Motor drives
- Servo drives
- UPS systems

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

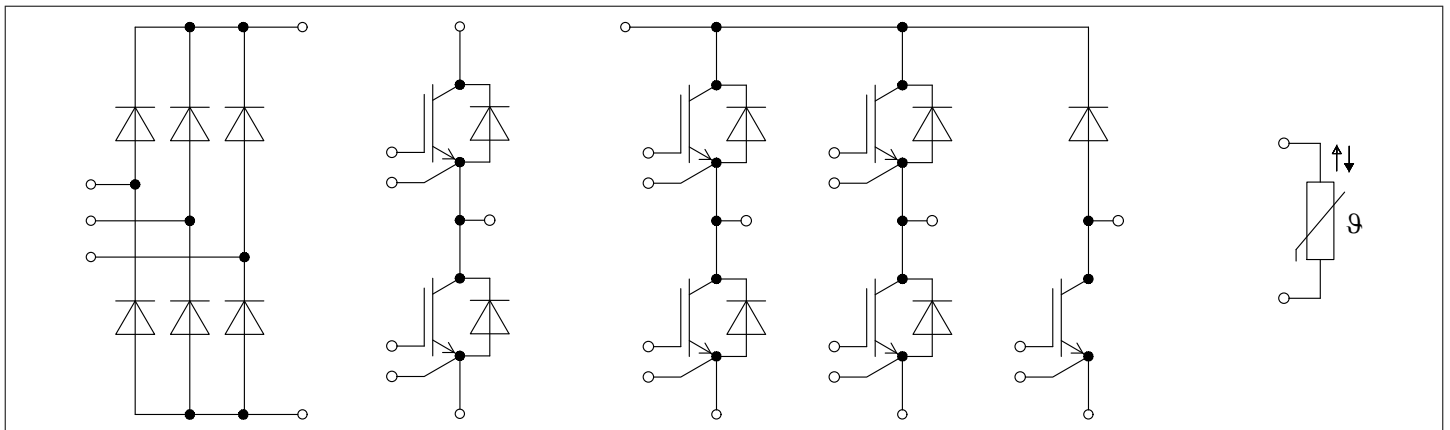


Table of contents

	Description	1
	Features	1
	Potential applications	1
	Product validation	1
	Table of contents	2
1	Package	3
2	IGBT, Inverter	3
3	Diode, Inverter	5
4	Diode, Rectifier	6
5	IGBT, Brake-Chopper	7
6	Diode, Brake-Chopper	8
7	NTC-Thermistor	9
8	Characteristics diagrams	10
9	Circuit diagram	16
10	Package outlines	16
11	Module label code	17
	Revision history	18
	Disclaimer	19

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50$ Hz, $t = 1$ min	2.5	kV
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	11.2	mm
Creepage distance	d_{Creep}	terminal to terminal	6.8	mm
Clearance	d_{Clear}	terminal to heatsink	9.4	mm
Clearance	d_{Clear}	terminal to terminal	5.5	mm
Comparative tracking index	CTI		> 400	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{SCE}			35		nH
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_H = 25^\circ C$, per switch		2.8		mΩ
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_H = 25^\circ C$, per switch		2.2		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting torque for module mounting	M	- Mounting according to valid application note	M5, Screw	1.3	1.5	Nm
Weight	G			78		g

Note: The current under continuous operation is limited to 25 A rms per connector pin.

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25^\circ C$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj\ max} = 175^\circ C$ $T_H = 65^\circ C$	100	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\ op}$	200	A
Gate-emitter peak voltage	V_{GES}		±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 100\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.50	1.80	V
			$T_{vj} = 125\ ^\circ C$		1.64		
			$T_{vj} = 175\ ^\circ C$		1.72		
Gate threshold voltage	V_{GETh}	$I_C = 2.5\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		5.15	5.80	6.45	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V, V_{CC} = 600\ V$			1.8		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$			1.5		Ω
Input capacitance	C_{ies}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			21.7		nF
Reverse transfer capacitance	C_{res}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.076		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200\ V, V_{GE} = 0\ V$	$T_{vj} = 125\ ^\circ C$			0.018	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 100\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 3.3\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.163		μs
			$T_{vj} = 125\ ^\circ C$		0.184		
			$T_{vj} = 175\ ^\circ C$		0.193		
Rise time (inductive load)	t_r	$I_C = 100\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 3.3\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.054		μs
			$T_{vj} = 125\ ^\circ C$		0.056		
			$T_{vj} = 175\ ^\circ C$		0.057		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 100\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 3.3\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.328		μs
			$T_{vj} = 125\ ^\circ C$		0.410		
			$T_{vj} = 175\ ^\circ C$		0.459		
Fall time (inductive load)	t_f	$I_C = 100\ A, V_{CC} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 3.3\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.114		μs
			$T_{vj} = 125\ ^\circ C$		0.197		
			$T_{vj} = 175\ ^\circ C$		0.258		
Turn-on energy loss per pulse	E_{on}	$I_C = 100\ A, V_{CC} = 600\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 3.3\ \Omega, di/dt = 1900\ A/\mu s (T_{vj} = 175\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		9.5		mJ
			$T_{vj} = 125\ ^\circ C$		12.6		
			$T_{vj} = 175\ ^\circ C$		14.3		
Turn-off energy loss per pulse	E_{off}	$I_C = 100\ A, V_{CC} = 600\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 3.3\ \Omega, dv/dt = 3000\ V/\mu s (T_{vj} = 175\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		6.85		mJ
			$T_{vj} = 125\ ^\circ C$		10.3		
			$T_{vj} = 175\ ^\circ C$		12.6		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
SC data	I_{SC}	$V_{CC} = 800\text{ V}, V_{CEmax}=V_{CES}$ $L_{sCE} \cdot di/dt$	$t_p \leq 8\ \mu\text{s},$ $T_{vj}=150\ \text{°C}$		370	A
			$t_p \leq 7\ \mu\text{s},$ $T_{vj}=175\ \text{°C}$		350	
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{grease} = 3.3\ \text{W}/(\text{m}\cdot\text{K})$		0.510		K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		175	°C

Note: $T_{vj\ op} > 150\ \text{°C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25\ \text{°C}$	1200	V	
Continuous DC forward current	I_F		100	A	
Repetitive peak forward current	I_{FRM}	$t_p = 1\ \text{ms}$	200	A	
I^2t - value	I^2t	$t_p = 10\ \text{ms}, V_R = 0\ \text{V}$	$T_{vj} = 125\ \text{°C}$	970	A ² s
			$T_{vj} = 175\ \text{°C}$	860	

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	V_F	$I_F = 100\ \text{A}, V_{GE} = 0\ \text{V}$	$T_{vj} = 25\ \text{°C}$		1.72	2.10	V
			$T_{vj} = 125\ \text{°C}$		1.59		
			$T_{vj} = 175\ \text{°C}$		1.52		
Peak reverse recovery current	I_{RM}	$V_{CC} = 600\ \text{V}, I_F = 100\ \text{A},$ $V_{GE} = -15\ \text{V}, -di_F/dt =$ $1900\ \text{A}/\mu\text{s} (T_{vj} = 175\ \text{°C})$	$T_{vj} = 25\ \text{°C}$		68.3		A
			$T_{vj} = 125\ \text{°C}$		84.6		
			$T_{vj} = 175\ \text{°C}$		92.8		

(table continues...)

Table 6 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Recovered charge	Q_r	$V_{CC} = 600\text{ V}, I_F = 100\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 1900\text{ A}/\mu\text{s} (T_{vj} = 175\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	9.38		μC
			$T_{vj} = 125\text{ }^\circ\text{C}$	14.9		
			$T_{vj} = 175\text{ }^\circ\text{C}$	19.1		
Reverse recovery energy	E_{rec}	$V_{CC} = 600\text{ V}, I_F = 100\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 1900\text{ A}/\mu\text{s} (T_{vj} = 175\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	3.02		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	5.18		
			$T_{vj} = 175\text{ }^\circ\text{C}$	6.5		
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 3.3\text{ W}/(\text{m}\cdot\text{K})$		0.870		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		175	$^\circ\text{C}$

Note: $T_{vj\text{ op}} > 150\text{ }^\circ\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

4 Diode, Rectifier

Table 7 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25\text{ }^\circ\text{C}$	1600	V	
Maximum RMS forward current per chip	I_{FRMSM}	$T_H = 95\text{ }^\circ\text{C}$	100	A	
Maximum RMS current at rectifier output	I_{RMSM}	$T_H = 95\text{ }^\circ\text{C}$	100	A	
Surge forward current	I_{FSM}	$t_p = 10\text{ ms}$	$T_{vj} = 25\text{ }^\circ\text{C}$	1150	A
			$T_{vj} = 150\text{ }^\circ\text{C}$	880	
I^2t - value	I^2t	$t_p = 10\text{ ms}$	$T_{vj} = 25\text{ }^\circ\text{C}$	6610	A^2s
			$T_{vj} = 150\text{ }^\circ\text{C}$	3870	

Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 100\text{ A}, T_{vj} = 150\text{ }^\circ\text{C}$		1.02		V
Reverse current	I_r	$T_{vj} = 150\text{ }^\circ\text{C}, V_R = 1600\text{ V}$		1		mA
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 3.3\text{ W}/(\text{m}\cdot\text{K})$		0.700		K/W

(table continues...)

Table 8 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj,op}$		-40		150	°C

5 IGBT, Brake-Chopper

Table 9 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25\text{ °C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj,max} = 175\text{ °C}$ $T_H = 85\text{ °C}$	50	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj,op}$	100	A
Gate-emitter peak voltage	V_{GES}		±20	V

Table 10 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\,sat}$	$I_C = 50\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.50	1.80	V
			$T_{vj} = 125\text{ °C}$	1.64		
			$T_{vj} = 175\text{ °C}$	1.72		
Gate threshold voltage	V_{GETh}	$I_C = 1.28\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25\text{ °C}$	5.15	5.80	6.45	V
Gate charge	Q_G	$V_{GE} = \pm 15\text{ V}, V_{CC} = 600\text{ V}$		0.92		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\text{ °C}$		0		Ω
Input capacitance	C_{ies}	$f = 100\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		11.1		nF
Reverse transfer capacitance	C_{res}	$f = 100\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		0.039		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200\text{ V}$ $T_{vj} = 25\text{ °C}$			0.01	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25\text{ °C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 5.1\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.045		μs
			$T_{vj} = 125\text{ °C}$	0.047		
			$T_{vj} = 175\text{ °C}$	0.048		
Rise time (inductive load)	t_r	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 5.1\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.031		μs
			$T_{vj} = 125\text{ °C}$	0.034		
			$T_{vj} = 175\text{ °C}$	0.035		

(table continues...)

Table 10 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time (inductive load)	t_{doff}	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 5.1\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.255		μs
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.340		
			$T_{vj} = 175\text{ }^\circ\text{C}$	0.382		
Fall time (inductive load)	t_f	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 5.1\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.107		μs
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.195		
			$T_{vj} = 175\text{ }^\circ\text{C}$	0.255		
Turn-on energy loss per pulse	E_{on}	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, L_\sigma = 35\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 5.1\ \Omega, di/dt = 1200\text{ A}/\mu\text{s} (T_{vj} = 175\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	3.21		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	4.03		
			$T_{vj} = 175\text{ }^\circ\text{C}$	4.46		
Turn-off energy loss per pulse	E_{off}	$I_C = 50\text{ A}, V_{CC} = 600\text{ V}, L_\sigma = 35\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 5.1\ \Omega, dv/dt = 2900\text{ V}/\mu\text{s} (T_{vj} = 175\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	3.23		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	5.22		
			$T_{vj} = 175\text{ }^\circ\text{C}$	6.45		
SC data	I_{SC}	$V_{CC} = 800\text{ V}, V_{CEmax} = V_{CES-}, L_{sCE} * di/dt$	$t_p \leq 8\ \mu\text{s}, T_{vj} = 150\text{ }^\circ\text{C}$	185		A
			$t_p \leq 7\ \mu\text{s}, T_{vj} = 175\text{ }^\circ\text{C}$	175		
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{grease} = 3.3\text{ W}/(\text{m}\cdot\text{K})$		0.850		K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		175	$^\circ\text{C}$

Note: $T_{vj\ op} > 150\text{ }^\circ\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

6 Diode, Brake-Chopper

Table 11 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25\text{ }^\circ\text{C}$	1200	V	
Continuous DC forward current	I_F		25	A	
Repetitive peak forward current	I_{FRM}	$t_p = 1\text{ ms}$	50	A	
I^2t - value	I^2t	$t_p = 10\text{ ms}, V_R = 0\text{ V}$	$T_{vj} = 125\text{ }^\circ\text{C}$	72.5	A^2s
			$T_{vj} = 175\text{ }^\circ\text{C}$	63	

Table 12 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	V_F	$I_F = 25 \text{ A}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$		1.83	2.30	V
			$T_{vj} = 125 \text{ °C}$		1.70		
			$T_{vj} = 175 \text{ °C}$		1.63		
Peak reverse recovery current	I_{RM}	$V_{CC} = 600 \text{ V}$, $I_F = 25 \text{ A}$, $V_{GE} = -15 \text{ V}$, $-di_F/dt = 1100 \text{ A}/\mu\text{s}$ ($T_{vj} = 175 \text{ °C}$)	$T_{vj} = 25 \text{ °C}$		27.4		A
			$T_{vj} = 125 \text{ °C}$		31.2		
			$T_{vj} = 175 \text{ °C}$		34.1		
Recovered charge	Q_r	$V_{CC} = 600 \text{ V}$, $I_F = 25 \text{ A}$, $V_{GE} = -15 \text{ V}$, $-di_F/dt = 1100 \text{ A}/\mu\text{s}$ ($T_{vj} = 175 \text{ °C}$)	$T_{vj} = 25 \text{ °C}$		1.93		μC
			$T_{vj} = 125 \text{ °C}$		3.51		
			$T_{vj} = 175 \text{ °C}$		4.51		
Reverse recovery energy	E_{rec}	$V_{CC} = 600 \text{ V}$, $I_F = 25 \text{ A}$, $V_{GE} = -15 \text{ V}$, $-di_F/dt = 1100 \text{ A}/\mu\text{s}$ ($T_{vj} = 175 \text{ °C}$)	$T_{vj} = 25 \text{ °C}$		0.74		mJ
			$T_{vj} = 125 \text{ °C}$		1.42		
			$T_{vj} = 175 \text{ °C}$		1.85		
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$			1.86		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$			-40		175	$^{\circ}\text{C}$

Note: $T_{vj\text{ op}} > 150^{\circ}\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

7 NTC-Thermistor

Table 13 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ °C}$		5		k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ °C}$, $R_{100} = 493 \text{ }\Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

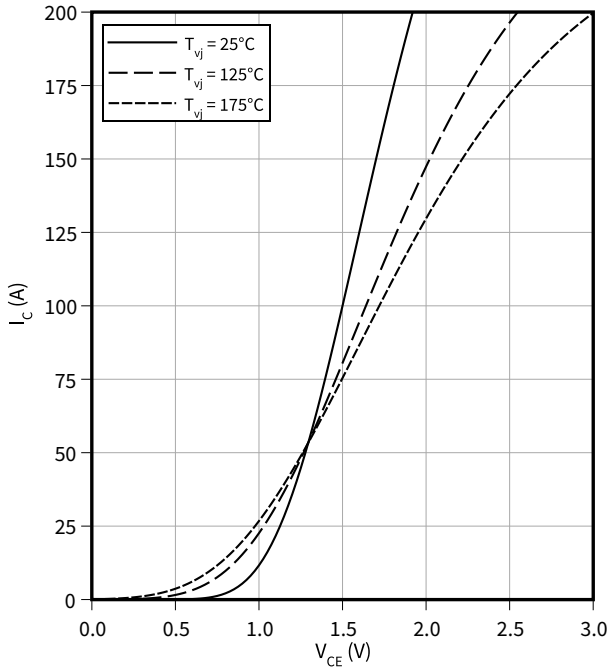
Note: Specification according to the valid application note.

8 Characteristics diagrams

Output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

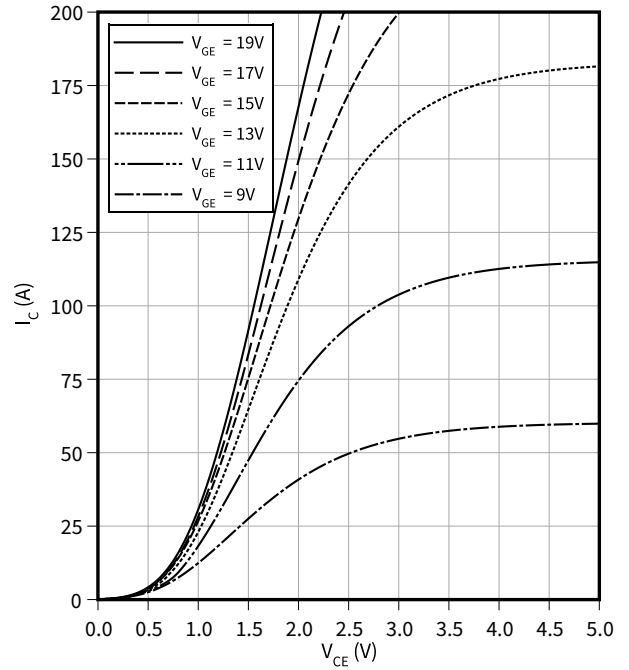
$$V_{GE} = 15 \text{ V}$$



Output characteristic field (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

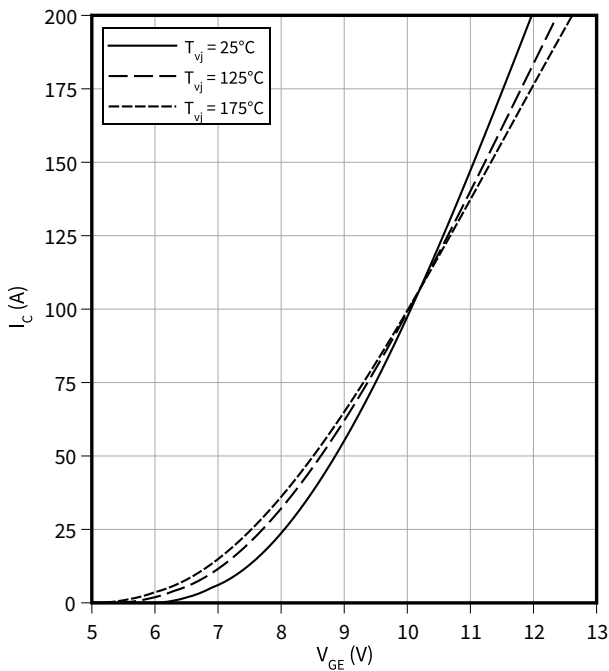
$$T_{vj} = 175 \text{ °C}$$



Transfer characteristic (typical), IGBT, Inverter

$$I_C = f(V_{GE})$$

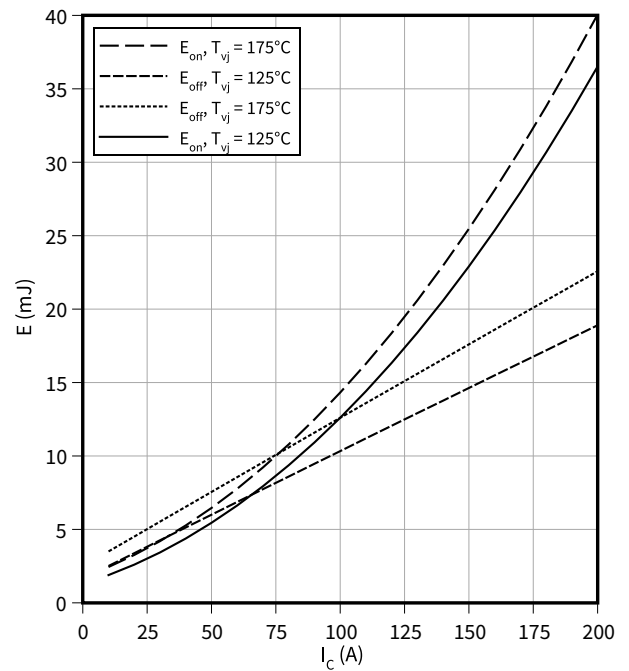
$$V_{CE} = 20 \text{ V}$$



Switching losses (typical), IGBT, Inverter

$$E = f(I_C)$$

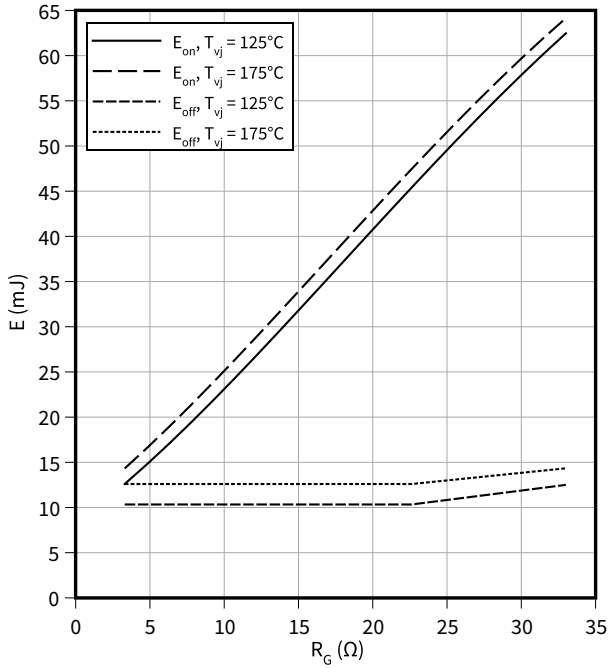
$$R_{Goff} = 3.3 \text{ } \Omega, R_{Gon} = 3.3 \text{ } \Omega, V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$$



Switching losses (typical), IGBT, Inverter

$E = f(R_G)$

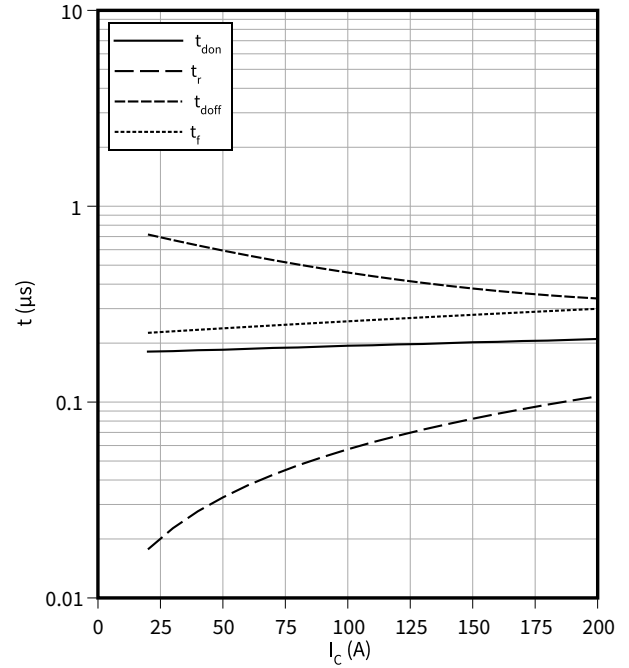
$I_C = 100 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$



Switching times (typical), IGBT, Inverter

$t = f(I_C)$

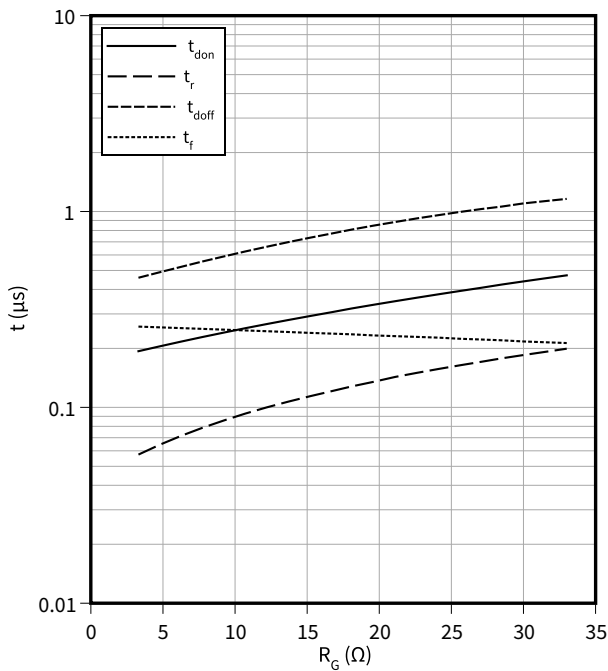
$R_{Goff} = 3.3 \text{ } \Omega, R_{Gon} = 3.3 \text{ } \Omega, V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 175 \text{ } ^\circ\text{C}$



Switching times (typical), IGBT, Inverter

$t = f(R_G)$

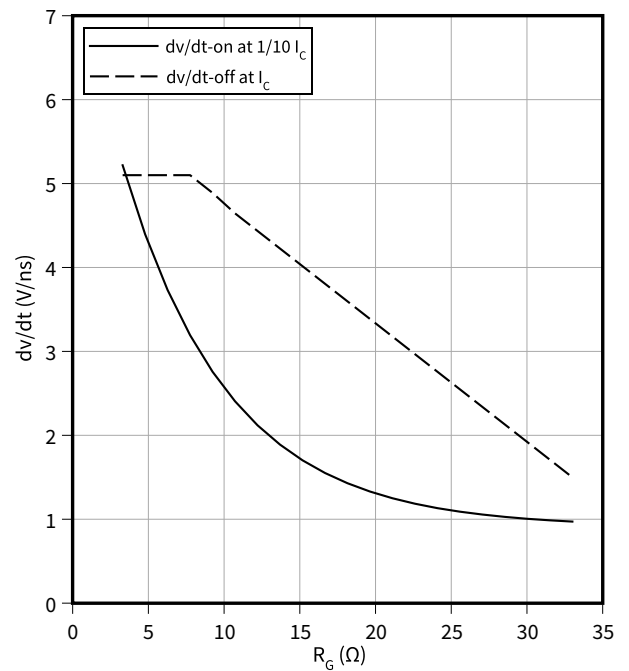
$I_C = 100 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 175 \text{ } ^\circ\text{C}$



Voltage slope (typical), IGBT, Inverter

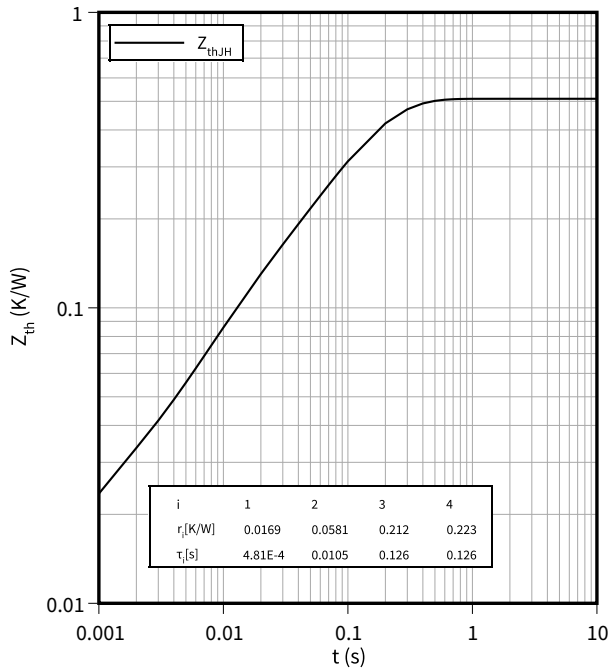
$dv/dt = f(R_G)$

$I_C = 100 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 25 \text{ } ^\circ\text{C}$



Transient thermal impedance, IGBT, Inverter

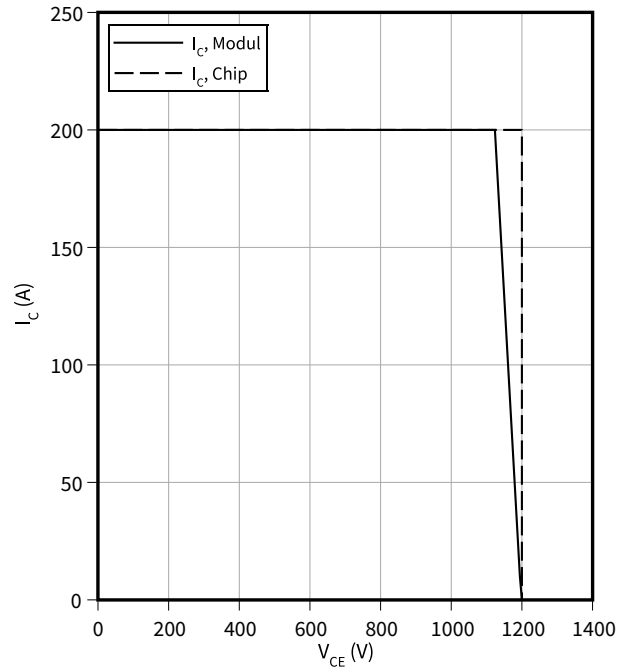
$Z_{th} = f(t)$



Reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C = f(V_{CE})$

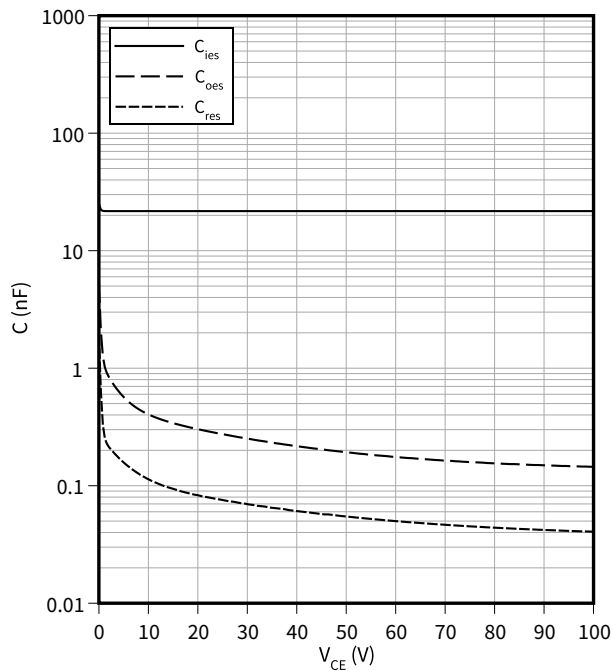
$R_{Goff} = 3.3 \Omega, V_{GE} = \pm 15.0 V, T_{vj} = 175 \text{ }^\circ\text{C}$



Capacity characteristic (typical), IGBT, Inverter

$C = f(V_{CE})$

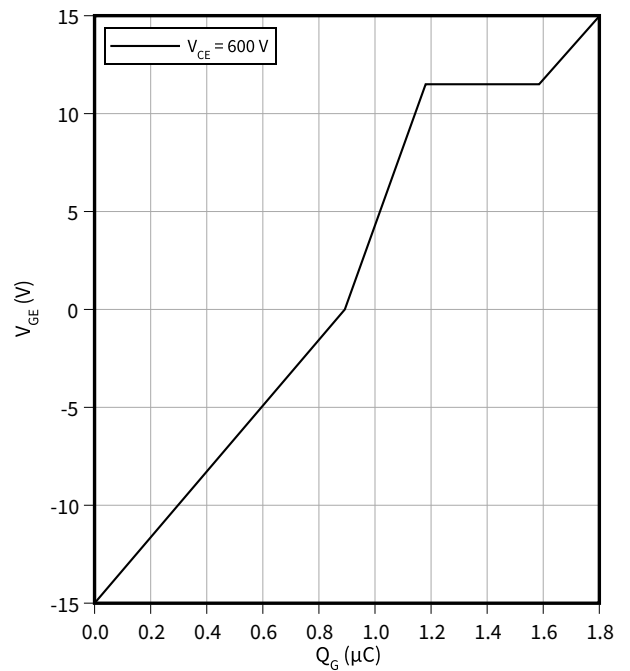
$f = 100 \text{ kHz}, V_{GE} = 0 V, T_{vj} = 25 \text{ }^\circ\text{C}$



Gate charge characteristic (typical), IGBT, Inverter

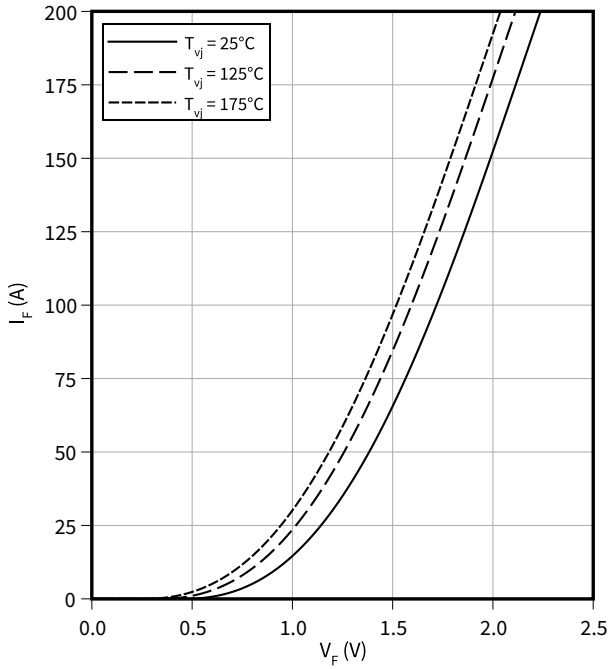
$V_{GE} = f(Q_G)$

$I_C = 100 A, T_{vj} = 25 \text{ }^\circ\text{C}$



Forward characteristic (typical), Diode, Inverter

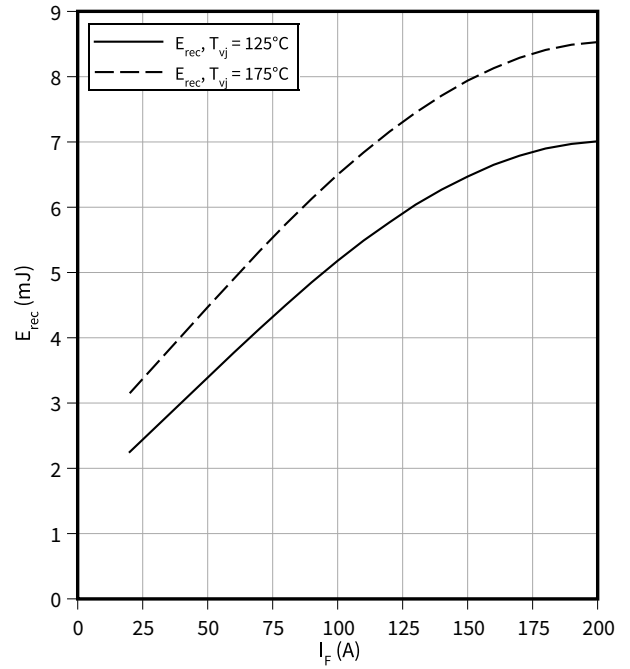
$I_F = f(V_F)$



Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$

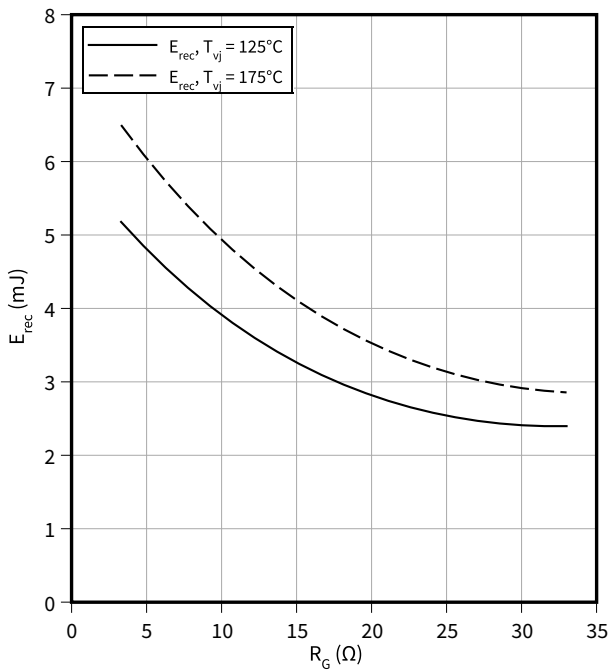
$R_{Gon} = 3.3, V_{CC} = 600\text{ V}$



Switching losses (typical), Diode, Inverter

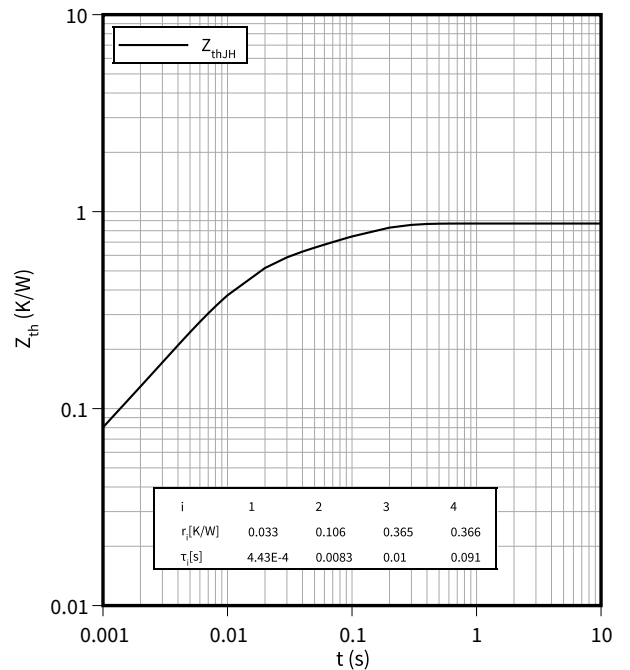
$E_{rec} = f(R_G)$

$I_F = 100\text{ A}, V_{CC} = 600\text{ V}$



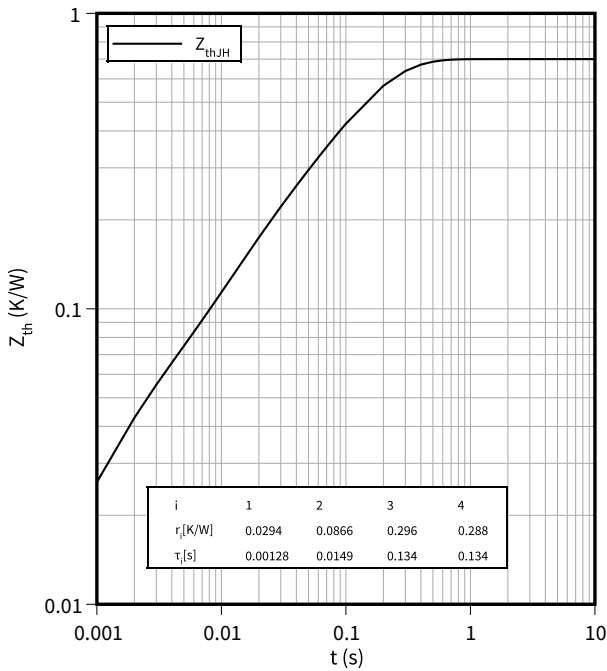
Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



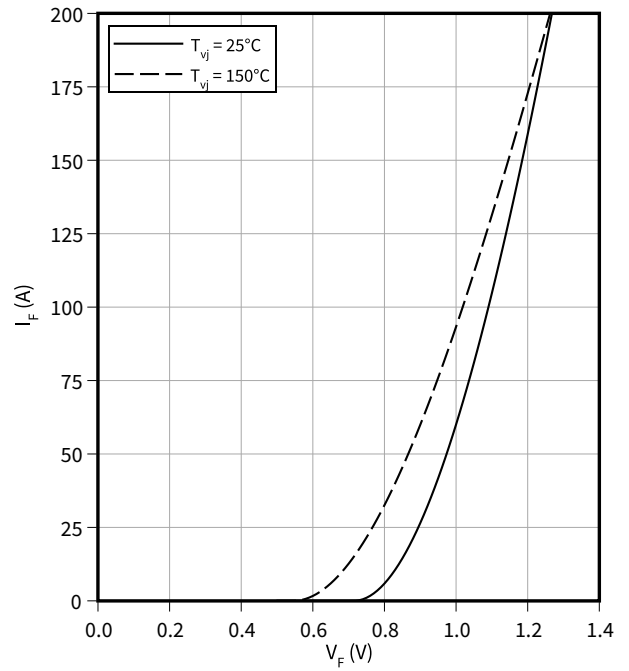
Transient thermal impedance, Diode, Rectifier

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Rectifier

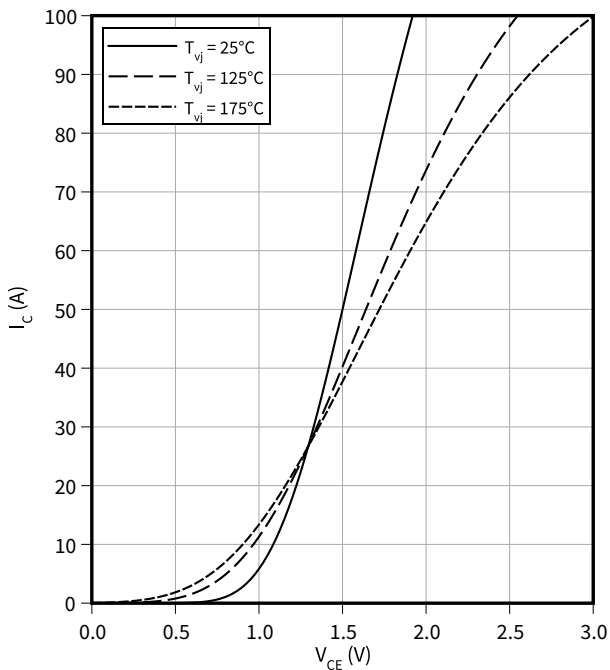
$I_F = f(V_F)$



Output characteristic (typical), IGBT, Brake-Chopper

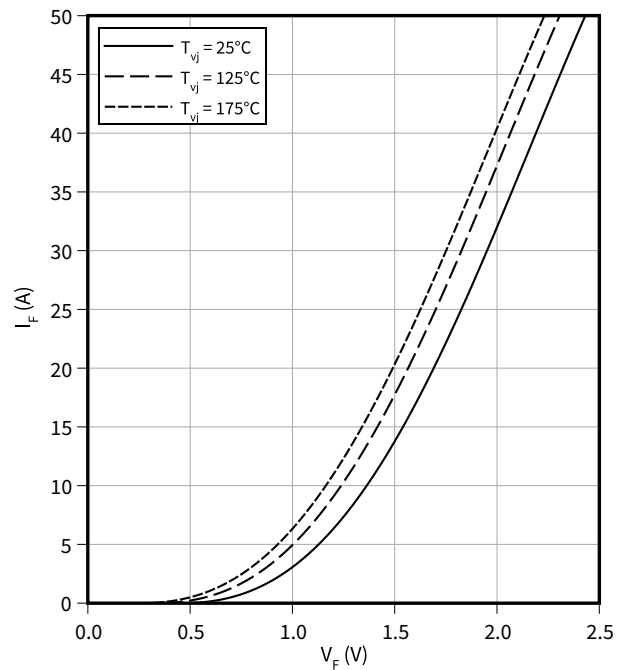
$I_C = f(V_{CE})$

$V_{GE} = 15 \text{ V}$



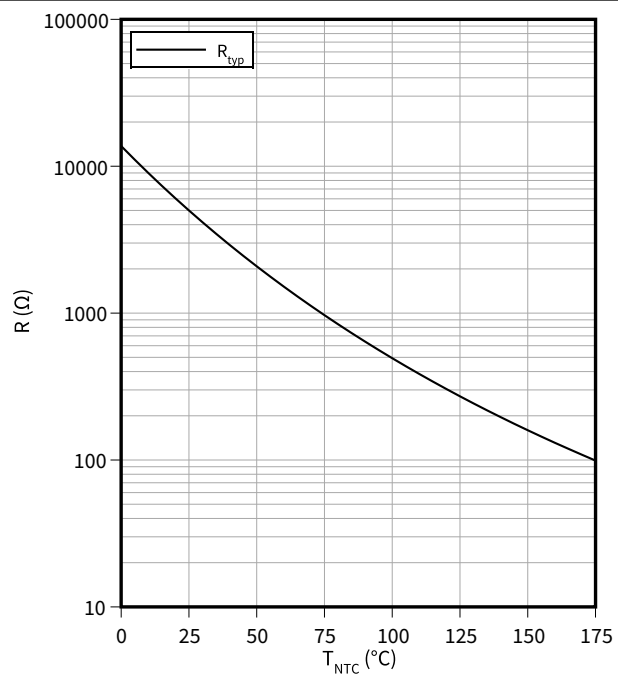
Forward characteristic (typical), Diode, Brake-Chopper

$I_F = f(V_F)$



Temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



9 Circuit diagram

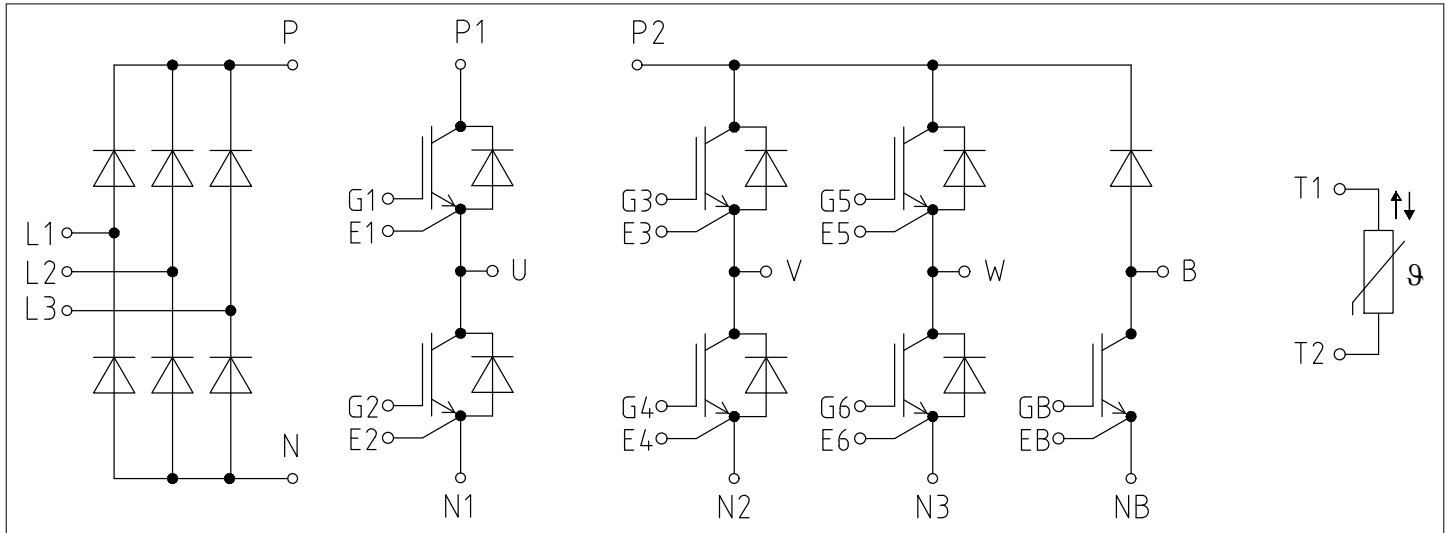


Figure 1

10 Package outlines

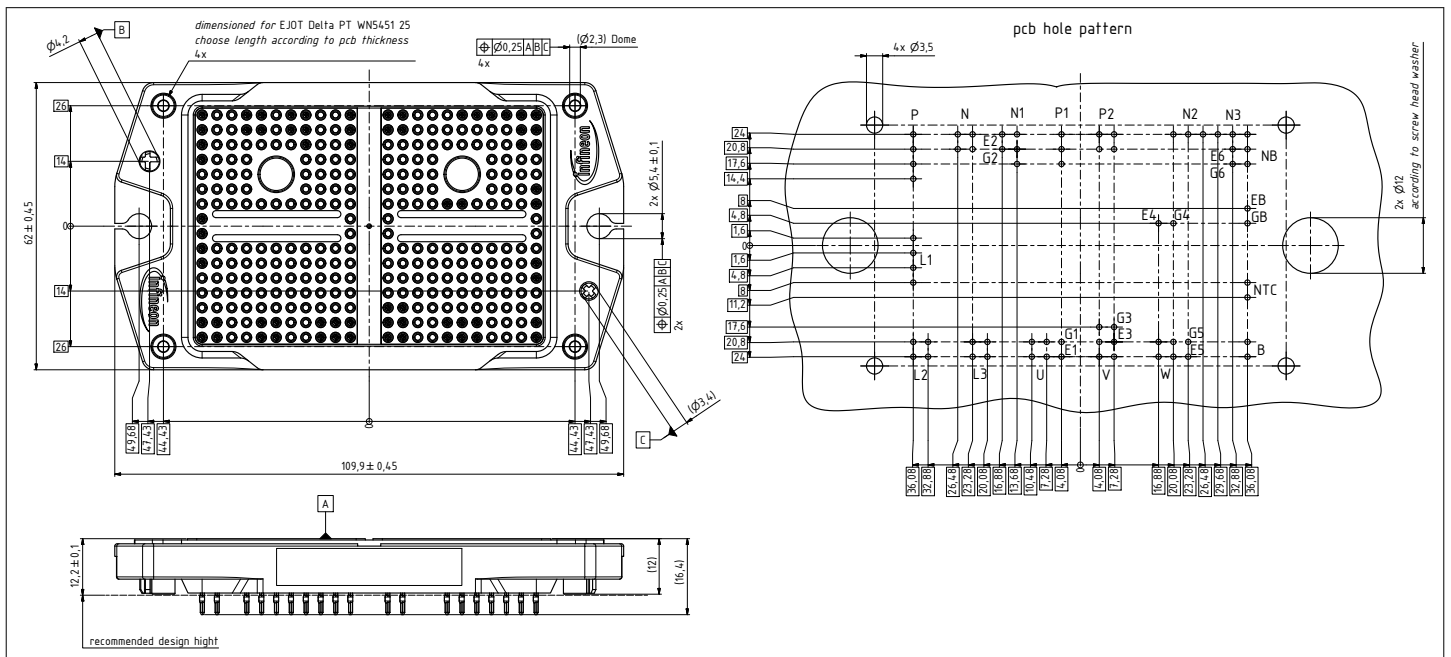


Figure 2

11 Module label code


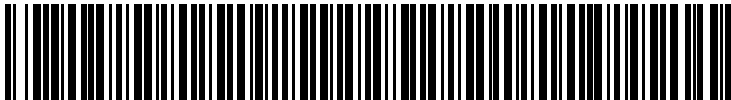
Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 - 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 - 21	15
	Date code (production week)	22 - 23	30
Example	 		
	71549142846550549911530		71549142846550549911530

Figure 3

Revision history

Document revision	Date of release	Description of changes
V1.0	2019-03-15	Target datasheet
V1.1	2019-09-11	Target datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
0.20	2020-11-12	
0.20	2020-11-13	
1.00	2022-10-05	Final datasheet

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Document reference

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